National *Semiconductor*

May 1989

DM54LS190/DM74LS190, DM54LS191/DM74LS191 Synchronous 4-Bit Up/Down Counters with Mode Control

General Description

These circuits are synchronous, reversible, up/down counters. The LS191 is a 4-bit binary counter and the LS190 is a BCD counter. Synchronous operation is provided by having all flip-flops clocked simultaneously, so that the outputs change simultaneously when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

The outputs of the four master-slave flip-flops are triggered on a low-to-high level transition of the clock input, if the enable input is low. A high at the enable input inhibits counting. Level changes at either the enable input or the down/up input should be made only when the clock input is high. The direction of the count is determined by the level of the down/up input. When low, the counter counts up and when high, it counts down.

These counters are fully programmable; that is, the outputs may be preset to either level by placing a low on the load input and entering the desired data at the data inputs. The output will change independent of the level of the clock input. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

The clock, down/up, and load inputs are buffered to lower the drive requirement; which significantly reduces the number of clock drivers, etc., required for long parallel words.

Two outputs have been made available to perform the cascading function: ripple clock and maximum/minimum count. The latter output produces a high-level output pulse with a duration approximately equal to one complete cycle of the clock when the counter overflows or underflows. The ripple clock output produces a low-level output pulse equal in width to the low-level portion of the clock input when an overflow or underflow condition exists. The counters can be easily cascaded by feeding the ripple clock output to the enable input of the succeeding counter if parallel clocking is used, or to the clock input if parallel enabling is used. The maximum/minimum count output can be used to accomplish look-ahead for high-speed operation.

Features

- Counts 8-4-2-1 BCD or binary
- Single down/up count control line
- Count enable control input
- Ripple clock output for cascading
- Asynchronously presettable with load control
- Parallel outputs
- Cascadable for n-bit applications
- Average propagation delay 20 ns
- Typical clock frequency 25 MHz
- Typical power dissipation 100 mW

Connection Diagram

Dual-In-Line-Package
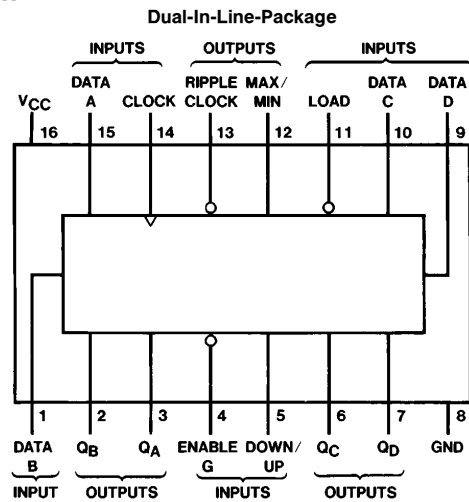
TL/F/6405-1

Order Number DM54LS190J, DM54LS191J, DM54LS190W, DM54LS191W, DM74LS190M, DM74LS191M, DM74LS190N, or DM74LS191N
See NS Package Number
J16A, M16A, N16A or W16A

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	
DM54LS	$-55°C$ to $+125°C$
DM74LS	$0°C$ to $+70°C$
Storage Temperature Range	$-65°C$ to $+150°C$

Note: *The ''Absolute Maximum Ratings'' are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the ''Electrical Characteristics'' table are not guaranteed at the absolute maximum ratings. The ''Recommended Operating Conditions'' table will define the conditions for actual device operation.*

Recommended Operating Conditions

Symbol	Parameter		DM54LS190, LS191			DM74LS190, LS191			Units
			Min	Nom	Max	Min	Nom	Max	
V_{CC}	Supply Voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High Level Input Voltage		2			2			V
V_{IL}	Low Level Input Voltage				0.7			0.8	V
I_{OH}	High Level Output Current				-0.4			-0.4	mA
I_{OL}	Low Level Output Current				4			8	mA
f_{CLK}	Clock Frequency (Note 4)		0		20	0		20	MHz
t_W	Pulse Width (Note 4)	Clock	25			25			ns
		Load	35			35			
t_{SU}	Data Setup Time (Note 4)		20			20			ns
t_H	Data Hold Time (Note 4)		0			0			ns
t_{EN}	Enable Time to Clock (Note 4)		30			30			ns
T_A	Free Air Operating Temperature		-55		125	0		70	°C

'LS190 and 'LS191 Electrical Characteristics
over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ (Note 1)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = -18 mA				-1.5	V
V_{OH}	High Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max, V_{IH} = Min	DM54	2.5	3.4		
			DM74	2.7	3.4		V
V_{OL}	Low Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IL} = Max, V_{IH} = Min	DM54		0.25	0.4	
			DM74		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min	DM74		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max V_I = 7V	Enable			0.3	mA
			Others			0.1	
I_{IH}	High Level Input Current	V_{CC} = Max V_I = 2.7V	Enable			60	μA
			Others			20	
I_{IL}	Low Level Input Current	V_{CC} = Max V_I = 0.4V	Enable			-1.08	mA
			Others			-0.4	
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 2)	DM54	-20		-100	mA
			DM74	-20		-100	
I_{CC}	Supply Current	V_{CC} = Max (Note 3)			20	35	mA

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 3: I_{CC} is measured with all inputs grounded and all outputs open.

Note 4: T_A = 25°C and V_{CC} = 5V.

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## 'LS190 and 'LS191 Switching Characteristics

at V_{CC} = 5V and T_A = 25°C (See Section 1 for Test Waveforms and Output Load)

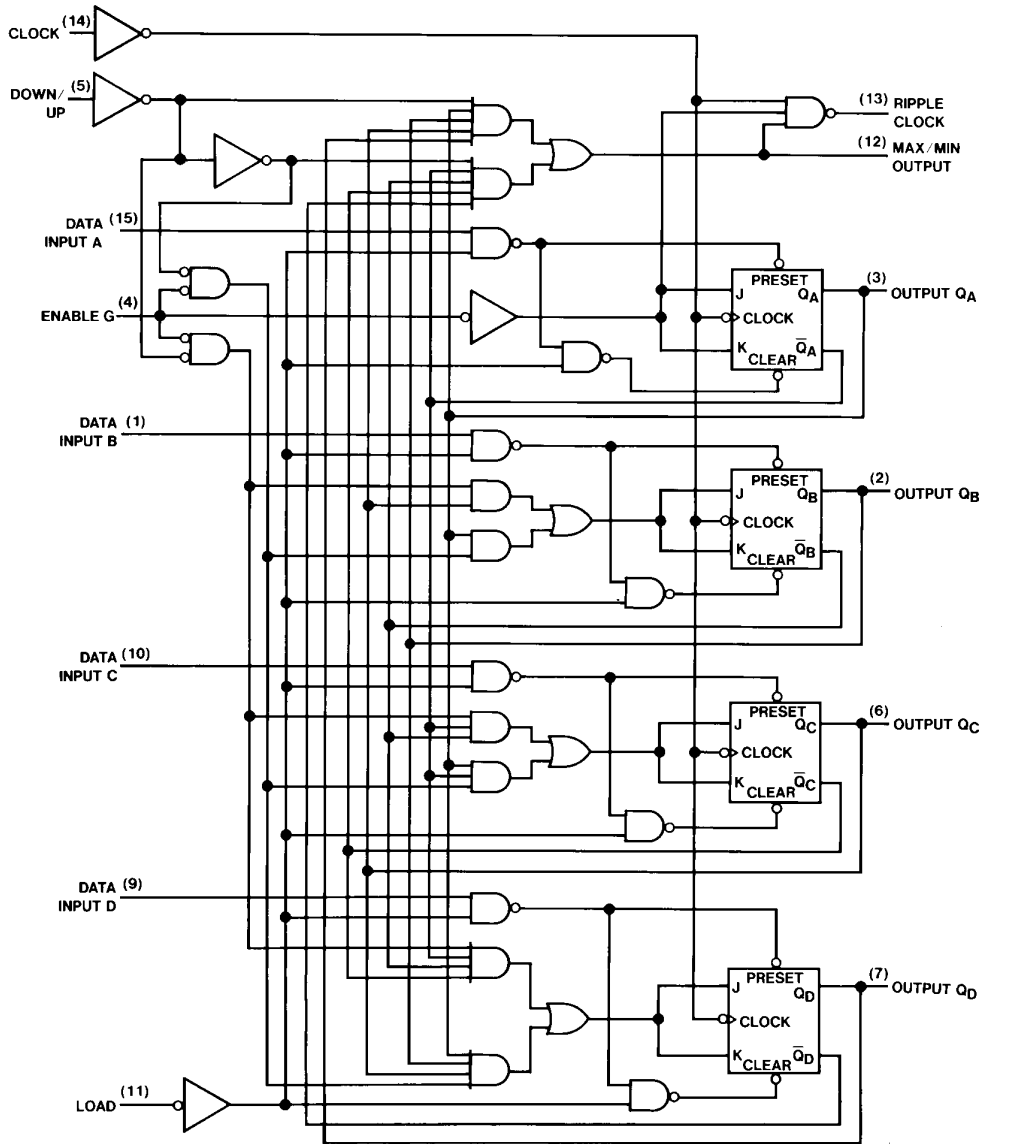| Symbol	Parameter	From (Input) To (Output)	R_L = 2 kΩ				Units
			C_L = 15 pF		C_L = 50 pF		
			Min	Max	Min	Max	
f_{MAX}	Maximum Clock Frequency		20		20		MHz
t_{PLH}	Propagation Delay Time Low to High Level Output	Load to Any Q		33		43	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Load to Any Q		50		59	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Data to Any Q		22		26	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Data to Any Q		50		62	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Clock to Ripple Clock		20		24	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Clock to Ripple Clock		24		33	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Clock to Any Q		24		29	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Clock to Any Q		36		45	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Clock to Max/Min		42		47	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Clock to Max/Min		52		65	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Up/Down to Ripple Clock		45		50	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Up/Down to Ripple Clock		45		54	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Down/Up to Max/Min		33		36	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Down/Up to Max/Min		33		42	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Enable to Ripple Clock		33		36	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Enable to Ripple Clock		33		42	ns

Logic Diagrams

LS190 Decade Counters
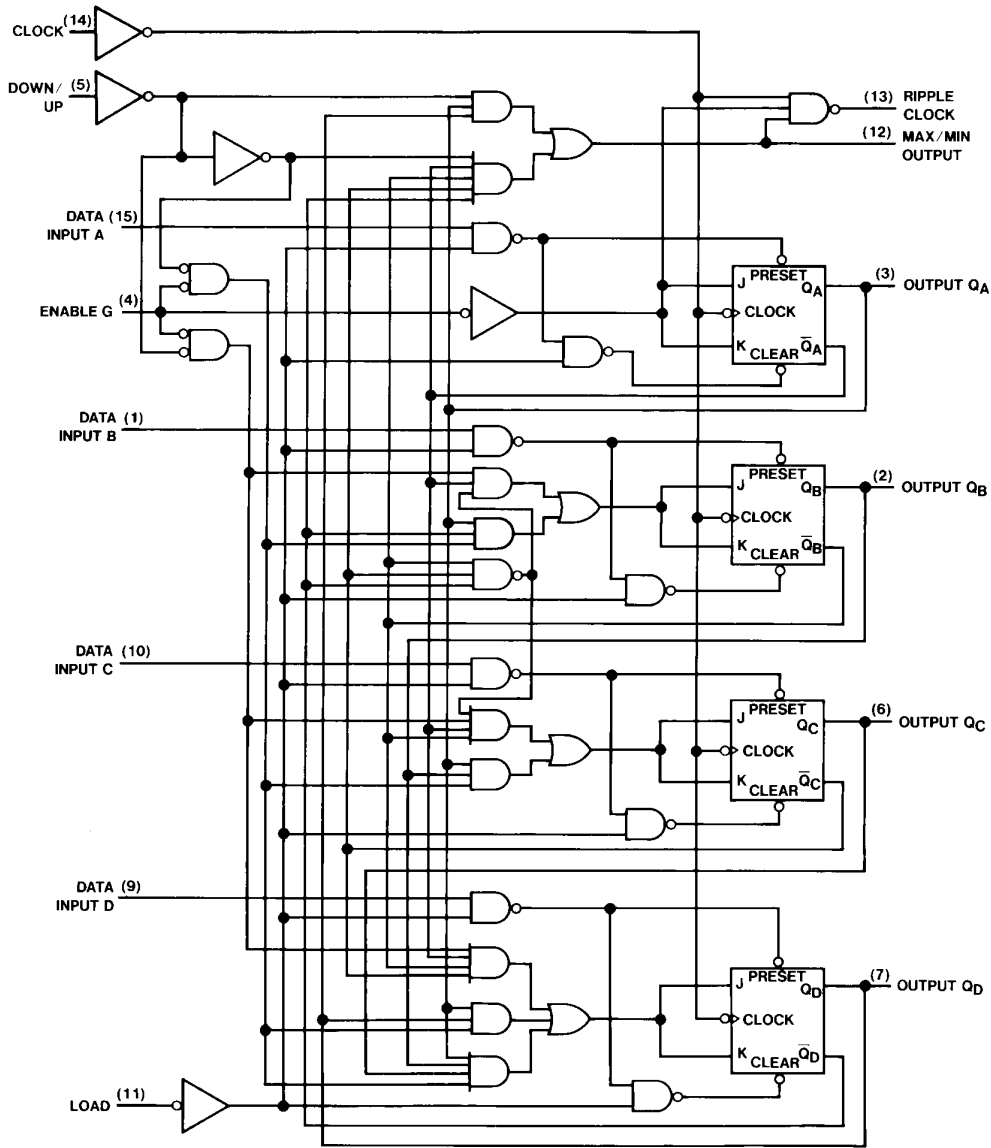
Pin (16) = V_CC, Pin (8) = GND

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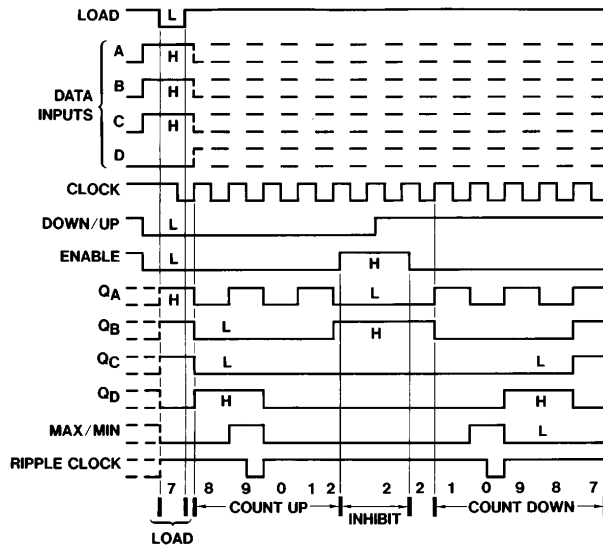# Logic Diagrams (Continued)

LS191 Binary Counters

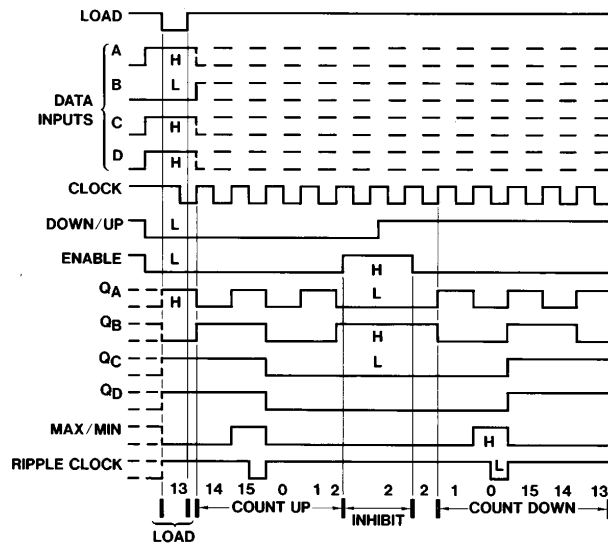TL/F/6405–3

Pin (16) = V_{CC}, Pin (8) = GND

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Timing Diagrams

LS190 Decade Counters
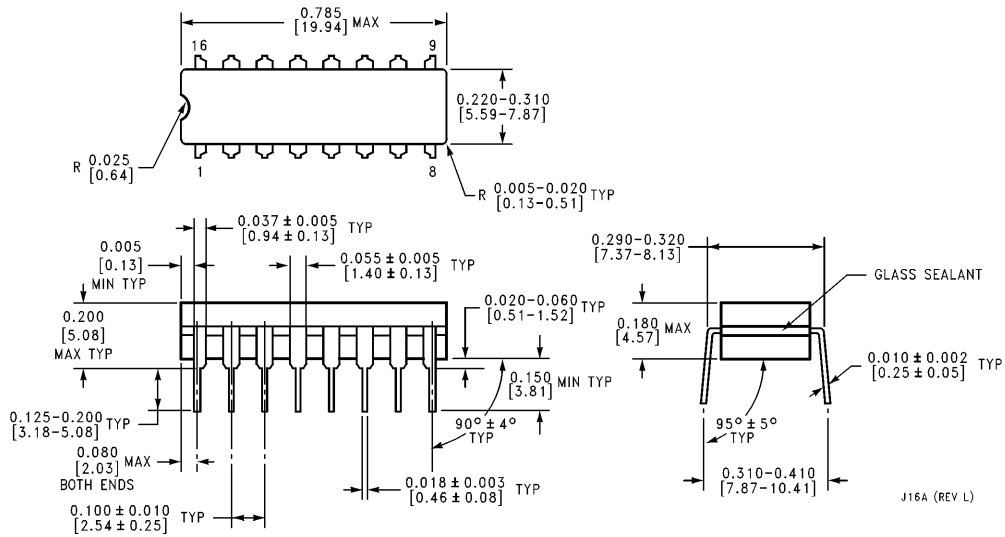### Typical Load, Count, and Inhibit Sequences

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LS191 Binary Counters
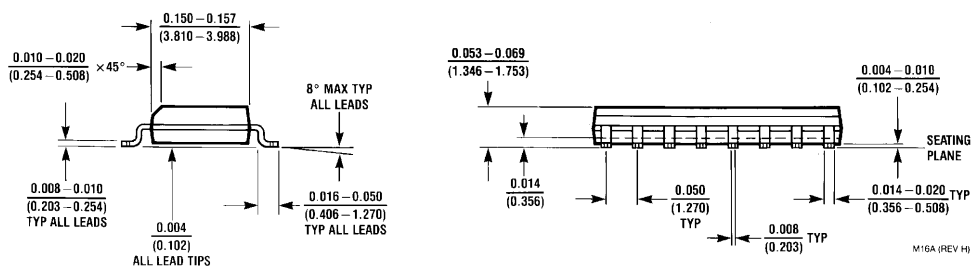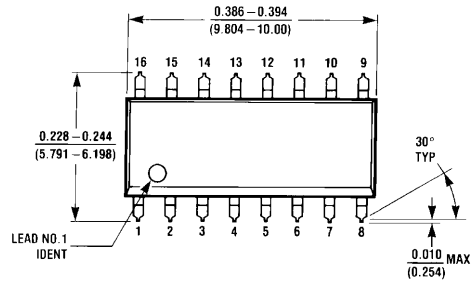### Typical Load, Count, and Inhibit Sequences
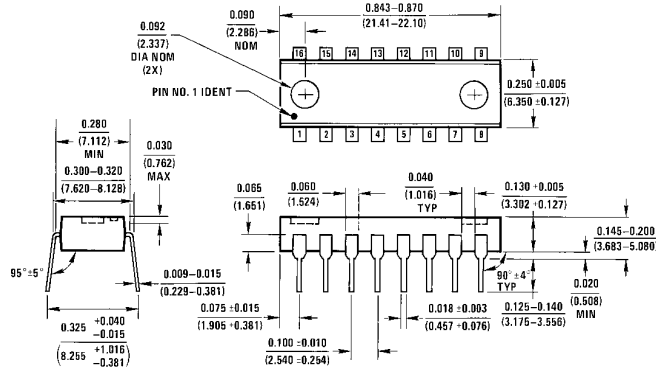

TL/F/6405–5

Physical Dimensions inches (millimeters)

0.785
[19.94] MAX

16   9

0.220-0.310
[5.59-7.87]

R 0.025
[0.64]

1   8

R 0.005-0.020 TYP
[0.13-0.51]

0.037 ± 0.005 TYP
[0.94 ± 0.13]

0.005
[0.13]
MIN TYP

0.055 ± 0.005 TYP
[1.40 ± 0.13]

0.020-0.060 TYP
[0.51-1.52]

0.200
[5.08]
MAX TYP

0.290-0.320
[7.37-8.13]

GLASS SEALANT

0.180 MAX
[4.57]

0.010 ± 0.002 TYP
[0.25 ± 0.05]

0.150 MIN TYP
[3.81]

0.125-0.200 TYP
[3.18-5.08]

90° ± 4°
TYP

0.080 MAX
[2.03]
BOTH ENDS

0.018 ± 0.003 TYP
[0.46 ± 0.08]

95° ± 5°
TYP

0.100 ± 0.010 TYP
[2.54 ± 0.25]

0.310-0.410
[7.87-10.41]

J16A (REV L)

16-Lead Ceramic Dual-In-Line Package (J)
Order Number DM54LS190J, DM54LS191J
NS Package Number J16A

0.386 − 0.394
(9.804 − 10.00)

16 15 14 13 12 11 10 9

0.228 − 0.244
(5.791 − 6.198)

30°
TYP

LEAD NO.1
IDENT

1   2   3   4   5   6   7   8

0.010 MAX
(0.254)

0.150 − 0.157
(3.810 − 3.988)

0.010 − 0.020 × 45°
(0.254 − 0.508)

8° MAX TYP
ALL LEADS

0.008 − 0.010
(0.203 − 0.254)
TYP ALL LEADS

0.004
(0.102)
ALL LEAD TIPS

0.016 − 0.050
(0.406 − 1.270)
TYP ALL LEADS

0.053 − 0.069
(1.346 − 1.753)

0.004 − 0.010
(0.102 − 0.254)

SEATING
PLANE

0.014
(0.356)

0.050
(1.270)
TYP

0.008 TYP
(0.203)

0.014 − 0.020 TYP
(0.356 − 0.508)

M16A (REV H)

16-Lead Small Outline Molded Package (M)
Order Number DM74LS190M, DM74LS191M
NS Package Number M16A

Physical Dimensions inches (millimeters) (Continued)

0.092
(2.337)
DIA NOM
(2X)

PIN NO. 1 IDENT

0.090
(2.286)
NOM

0.843−0.870
(21.41−22.10)

0.250 ±0.005
(6.350 ±0.127)

0.280
(7.112)
MIN

0.300−0.320
(7.620−8.128)

0.030
(0.762)
MAX

95°±5°

0.009−0.015
(0.229−0.381)

0.325 +0.040 −0.015
(8.255 +1.016 −0.381)

0.075 ±0.015
(1.905 ±0.381)

0.100 ±0.010
(2.540 ±0.254)

0.065
(1.651)

0.060
(1.524)

0.040
(1.016)
TYP

0.130 +0.005
(3.302 +0.127)

0.145−0.200
(3.683−5.080)

90° ±4°
TYP

0.020
(0.508)
MIN

0.018 ±0.003
(0.457 ±0.076)

0.125−0.140
(3.175−3.556)

N16A (REV E)

16-Lead Molded Dual-In-Line Package (N)
Order Number DM74LS190N, DM74LS191N
NS Package Number N16E

0.050 − 0.080
(1.270 − 2.032)

0.004 − 0.006
(0.102 − 0.152) TYP

0.371 − 0.390
(9.423 − 9.906)

0.007 − 0.018
(0.178 − 0.457)
TYP

0.050 ± 0.005
(1.270 ± 0.127) TYP

0.000 MIN TYP

0.250 − 0.370
(6.350 − 9.398)

0.300
(7.620)
MAX GLASS

0.245 − 0.275
(6.223 − 6.985)

DETAIL A

PIN NO. 1
IDENT

0.250 − 0.370
(6.350 − 9.398)

0.008 − 0.012
(0.203 − 0.305)

DETAIL A

0.026 − 0.040
(0.660 − 1.016) TYP

0.015 − 0.019
(0.381 − 0.482)
TYP

W16A (REV H)

16-Lead Ceramic Flat Package (W)
Order Number DM54LS190W or DM54LS191W
NS Package Number W16A

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.